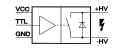
FAST HIGH VOLTAGE TRANSISTOR SWITCHES

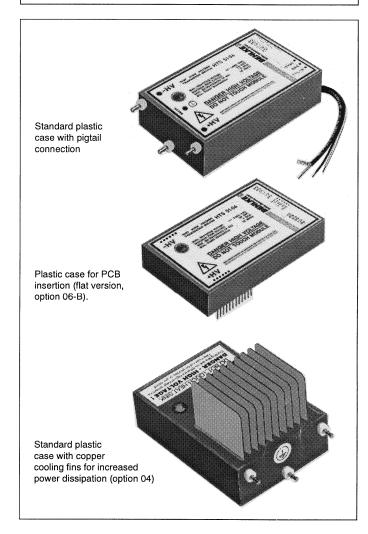
These MOSFET switches are designed for general high voltage switching applications such as pockels cell drivers, deflection and acceleration grid drivers, piezo drivers, MCP/SEV pulsers and DC/DC converters. The switching modules incorporate all features of the well known HTS switch family: Easy handling, high reliability, low jitter and precise switching. In contrast to conventional high voltage switches like spark gaps, electron tubes, gas discharge tubes and mechanical switches, HTS transistor switches show very stable switching characteristics independent of temperature and age. The mean time between failures (MTBF) is by several orders of magnitude higher than that of the classical HV switches. The switching modules are controlled by an interference-proof driver circuit which provides signal conditioning, auxiliary voltage monitoring, frequency limitation and temperature protection. In case of false operating conditions the switches are immediately turned-off and a fault signal is generated (not available for "pigtail" devices). The switches are turned-on by a positive going signal of 2 to 10 volts amplitude. The on-time may be varied between 100 ns and infinity. A short recovery time of 300 ns allows burst frequencies up to 3.3 MHz. Due to the galvanic isolation of more than 10 kV the switches may simply be operated also in high-side circuits. Three housing options are available to meet individual electrical and constructive requirements. plastic case is the cost-effective standard package in low frequency, pulsed power applications with a low continuous power dissipation. The standard housing has soldering terminals and "pigtails" for connection. It is also available as a printed circuit board version with soldering pins at bottom (option 06). To increase the Maximum Power Dissipation $P_{d(max)}$ the plastic modules can additionally be fitted with nonisolated cooling fins (option 04), which improve the $P_{d(max)}$ value by approximately the factor 5. A metal case for a continuous power dissipation of up to 400 Watt is also available (option 05, cf. data sheet "High Power Metal Case"). For detailed design recommendations please refer to the general instructions.

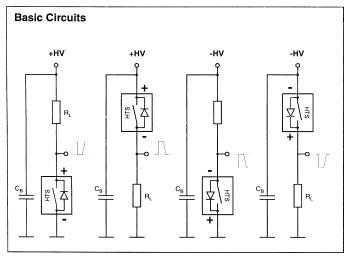
HTS 21-14 HTS 31-06 HTS 51-06

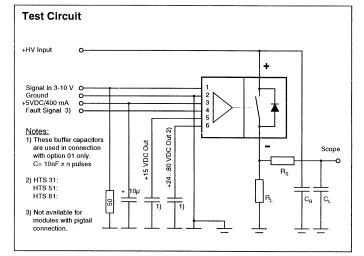
2000 VDC / 140 Amps 3000 VDC / 60 Amps 5000 VDC / 60 Amps

Low Impedance Variable On-Time











TECHNICAL DATA

Specification	Symbol	Condition / Comment		21-14	31-06	51-06	Unit
Maximum Operating Voltage	V _{O(max)}	I _{off} < 10 μADC		2000	3000	5000	VDC
Minimum Operating Voltage	$V_{O(min)}$	Increased $t_{r(on)}$ and $t_{r(off)}$ below 0.1x $V_{O(max)}$			0		VDC
Typical Breakdown Voltage	V _{br}	$I_{\text{off}} > 1 \text{mADC}, T_{\text{case}} = 70 ^{\circ}\text{C}$		2200	3300	5500	VDC
Galvanic Isolation	Vı	HV part against control, standard			>10000		VDC
Maximum Peak Current	I _{P(max)}	T _{case} = 25°C	t _p <10 μs, duty cycle <1%	140	60	60	
			t _p <100µs, duty cycle <1%	112	48	48	
			t _p <1 ms, duty cycle <1%	79	34	34	ADC
Maximum Continuous	IL	T _{case} = 25°C	Standard plastic case	2.2	1.2	0.9	
Load Current		respectively	Ditto + option 03	2.7	1.5	1.2	
		$T_{fin} = 25^{\circ}C$	Ditto +cooling fins (opt. 04)	5.5	3	2.3	
			Metal case B1 (opt. 05)	14.1	6.1	6	ADC
Static On-Resistance	R _{stat}	T _{case} = 25°C	0.1 x I _{P(max)}	1	3	5	
			@ I _{P(max)}	2	6.5	11	Ω
Maximum Off-State Current	I _{off}	0.8 x V _O , T _{case} = 2570°C			5		μADC
Turn-On Delay Time	t _{d(on)}	@ I _{P(max)}		100		ns	
Typical Turn-On Rise Time	t _{r(on)}	0.8 x V _O ,	0.1 x I _{P(max)}	5	4.5	4.0	1
,,	.()	10-90 %	1.0 x I _{P(max)}	25	14	15	ns
Typical Turn-Off Rise Time	t _{r(off)}	0.8xV ₀ 0.1x l ₁	P(max), resistive load, 10-90%		8		ns
Minimum On-Time	t _{on(min)}	Limited by driv	•		100		ns
Maximum On-Time	t _{on(max)}		ossible P _{d(max)} limitations		∞		1.0
Switch Recovery Time	t _{rc}		·		300		ns
Typical Turn-On Jitter	t _{i(on)}	t _{rc} = minimum pulse spacing V _{aux} / V _{tr} = 5.0 VDC			100		ps
Max. Switching Frequency	f _(max)	Please note possible P _{d(max)} limitations		50	70	50	kHz
Maximum Burst Frequency		Use option 01 for >10 pulses within<20µs		30	3.3	30	MHz
Maximum Continuous Power	f _{b(max)}	T _{case} = 25°C	'	10	10	10	IVII IZ
Dissipation	$P_{d(max)}$	respectively	Standard plastic case Ditto + option 03	15	15	15	
Dissipation		T _{fin} = 25°C	Ditto +cooling fins (opt. 04)	60	36	60	
		1 tin = 23 0	Metal case B1 (opt. 05)	400	240	400	Watts
Lincar Daratina		Above 25 °C	1 1 1				
Linear Derating		Above 25 C	Standard plastic case Ditto + option 03	0.22 0.33	0.22 0.33	0.22 0.33	
			Ditto + option 03 Ditto + cooling fins (opt. 04)	1.33	0.33	1.33	
			Metal case B1 (opt. 05)	6.66	4	6.66	W/K
Temperature Range	To	Plactic case	,	0.00	-4070	0.00	VV/IX
Temperature Range	10	Plastic case, plastic case +cooling fins Metal case B1 (option 05) Capacitance between switch poles at Vo.			-4070 -3085		°C
Natural Canacitanas	C _N			60		45	
Natural Capacitance		Capacitance between switch poles at V _{O(max)} HV side against control side		60	75	45	pF
Coupling Capacitance	C _C			16	12	16	pF
Diode Reverse Recovery Time	t _{rrc}	$I_F=0.1xI_{P(max)}$	MOSFET parasitic diode		500	•	ns
Diode Forward Voltage Drop	V _F	$I_F=0.1xI_{P(max)}$	MOSFET parasitic diode	6	3.6	6	VDC
Auxiliary Supply Voltage	V _{aux}	Stabilized to ±	5%		5.0		VDC
Auxiliary Supply Current	I _{aux}	@ f _{max}			400		mADC
Control Signal	V _{tr}	> 3VDC recommended		2-10		VDC	
Fault Signal Output		TTL compatible, short circuit proof, L=Fault		H= 4 V, L= 0.5 V		VDC	
Dimensions	,			89 x 64 x 27			
		Flat plastic case (opt. 06-B)		89 x 64 x 19			
		Plastic case + cooling fins (opt. 04)		89 x 64 x 60			3
		1	Metal case B1 (opt. 05)		180 x 100 x 53.5		mm ³
Weight		Standard plastic case Flat plastic case (opt. 06-B) Plastic case + cooling fins (opt. 04)		250 190			
					350		
	1	Metal case B1	(υμι. υσ)		2500		g

Ordering Informations

HTS 21-14	Transistor switch, 2000 VDC, 140 Amps.	Option 04	Cooling fins, non-isolated
HTS 31-06	Transistor switch, 3000 VDC, 60 Amps.	Option 05	Metal case B1, potential-free (cf. separate data sheet)
HTS 51-06	Transistor switch, 5000 VDC, 60 Amps.	Option 06	Soldering pins for printed boards, module height 27 mm
Option 01	High frequency burst	Option 06-B	Ditto, module height 19 mm (options 02, 03, 04 excluded)
Option 02	Flame retardend casting resin UL94-VO	Option 08	30 kV instead of 10 kV isolation, module size on request
Option 03	Increased thermal conductivity	Option 08-B	80 kV instead of 10 kV isolation, module size on request

All data and specifications subject to change without notice. Custom designed devices on request.